

## SURFACE MOUNT GLASS PASSIVATED SILICON RECTIFIERS

Reverse Voltage - 50 to 1000 V

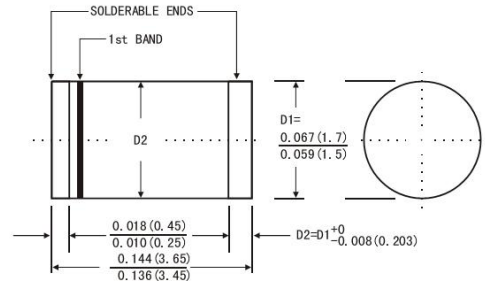
Forward Current - 1 A

### Features

- The plastic package carries Underwriters Laboratory Flammability classification 94V-0
- For surface mounted application
- Glass passivated junction

### Mechanical Data

- Case: MiniMELF(DO-213AA), molded plastic body
- Terminals: Lead solderable per MIL-STD-750, method 2026
- Polarity: Color band denotes cathode end
- Mounting Position: Any



MiniMELF (DO-213AA) Plastic Package

### Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbols	LM4001G	LM4002G	LM4003G	LM4004G	LM4005G	LM4006G	LM4007G	Units
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current at $T_A = 75\text{ }^\circ\text{C}$	$I_{(AV)}$	1							A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	$I_{FSM}$	25							A
Maximum Forward Voltage at 1 A	$V_F$	1.1							V
Maximum Reverse Current at Rated DC Blocking Voltage $T_A = 25\text{ }^\circ\text{C}$ $T_A = 125\text{ }^\circ\text{C}$	$I_R$	5 50							$\mu\text{A}$
Typical Junction Capacitance <sup>1)</sup>	$C_J$	15							pF
Typical Thermal Resistance <sup>2)</sup>	$R_{\theta JA}$	75							$^\circ\text{C}/\text{W}$
Typical Thermal Resistance <sup>3)</sup>	$R_{\theta JL}$	30							$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	$T_j, T_{stg}$	- 65 to + 175							$^\circ\text{C}$

<sup>1)</sup> Measured at 1 MHz and applied reverse voltage of 4 V D.C

<sup>2)</sup> Thermal resistance from junction to ambient, 0.24 X 0.24" (6 X 6 mm) copper pads to each terminal

<sup>3)</sup> Thermal resistance from junction to terminal, 0.24 X 0.24" (6 X 6 mm) copper pads to each terminal

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

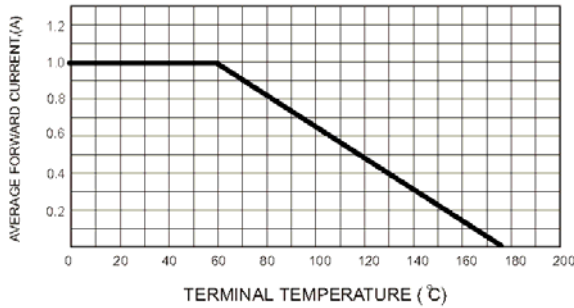


FIG.2-TYPICAL FORWARD CHARACTERISTICS

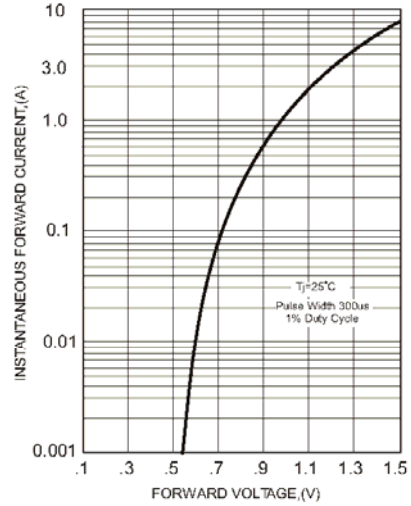


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

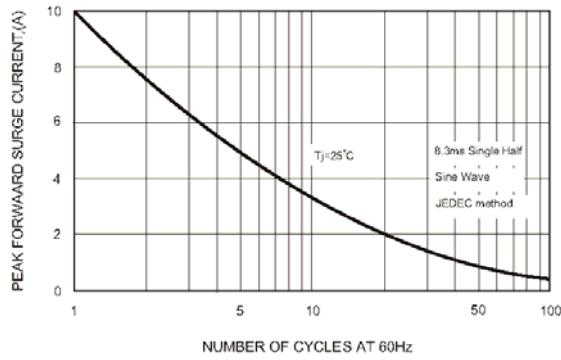


FIG.5 - TYPICAL REVERSE CHARACTERISTICS

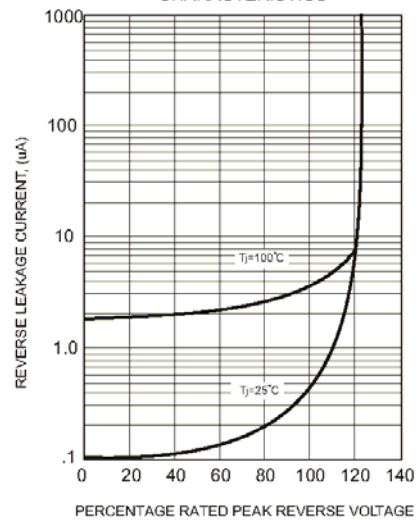


FIG.4-TYPICAL JUNCTION CAPACITANCE

